Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!

Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832
Email & Skype: info@chipsmall.com Web: www.chipsmall.com
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

BLF8G19LS-170BV

Power LDMOS transistor

Rev. 4 — 1 September 2015

AMPLEON

Product data sheet

1. Product profile

1.1 General description

170 W LDMOS power transistor with improved video bandwidth for base station applications at frequencies from 1800 MHz to 1990 MHz.

Table 1. Typical performance

Typical RF performance at T_{case} = 25 °C in a common source class-AB production test circuit.

Test signal	f	I_{Dq}	V_{DS}	$P_{L(AV)}$	G_p	η_D	ACPR
	(MHz)	(mA)	(V)	(W)	(dB)	(%)	(dBc)
2-carrier W-CDMA [1]	1930 to 1990	1300	32	60	18.0	32	–31
1-carrier W-CDMA [2]	1805 to 1880	1300	28	33	19.8	29	–40

[1] Test signal: 3GPP test model 1; 64 DPCH; PAR = 8.4 dB at 0.01 % probability on CCDF; carrier spacing 5 MHz.

[2] Test signal: 3GPP test model 1; 64 DPCH; PAR = 7.2 dB at 0.01 % probability on CCDF.

1.2 Features and benefits

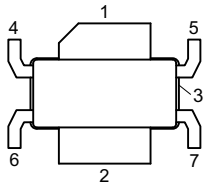
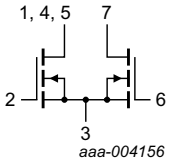
- Excellent ruggedness
- High efficiency
- Low thermal resistance providing excellent thermal stability
- Decoupling leads to enable improved video bandwidth (100 MHz typical)
- Lower output capacitance for improved performance in Doherty applications
- Designed for low memory effects providing excellent pre-distortability
- Internally matched for ease of use
- Integrated ESD protection
- Integrated current sense
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

1.3 Applications

- RF power amplifier for W-CDMA base stations and multi carrier applications in the 1800 MHz to 1990 MHz frequency range

2. Pinning information

Table 2. Pinning

Pin	Description	Simplified outline	Graphic symbol
1	drain		
2	gate		
3	source [1]		
4,5	video decoupling		
6	sense gate		
7	sense drain		

[1] Connected to flange.

3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BLF8G19LS-170BV	-	earless flanged LDMOST ceramic package; 6 leads	SOT1120B

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	drain-source voltage		-	65	V
V_{GS}	gate-source voltage		−0.5	+13	V
$V_{GS(sense)}$	sense gate-source voltage		−0.5	+9	V
T_{stg}	storage temperature		−65	+150	°C
T_j	junction temperature	[1]	-	225	°C

[1] Continuous use at maximum temperature will affect the reliability, for details refer to the on-line MTF calculator.

5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Typ	Unit
$R_{th(j-c)}$	thermal resistance from junction to case	T_{case} = 80 °C; P_L = 55 W	0.27	K/W

6. Characteristics

Table 6. DC characteristics

T_j = 25 °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{(BR)DSS}$	drain-source breakdown voltage	V_{GS} = 0 V; I_D = 2.16 mA	65	-	-	V
$V_{GS(th)}$	gate-source threshold voltage	V_{DS} = 10 V; I_D = 216 mA	1.5	1.9	2.3	V
I_{DSS}	drain leakage current	V_{GS} = 0 V; V_{DS} = 28 V	-	-	4.5	μA
I_{DSX}	drain cut-off current	V_{GS} = $V_{GS(th)}$ + 3.75 V; V_{DS} = 10 V	-	40	-	A
I_{GSS}	gate leakage current	V_{GS} = 11 V; V_{DS} = 0 V	-	-	450	nA
g_{fs}	forward transconductance	V_{DS} = 10 V; I_D = 10.8 A	-	16	-	S
$R_{DS(on)}$	drain-source on-state resistance	V_{GS} = $V_{GS(th)}$ + 3.75 V; I_D = 7.56 A	-	0.06	-	Ω
I_{Dq}	quiescent drain current	main transistor: V_{DS} = 32 V sense transistor: I_{DS} = 23.4 mA; V_{DS} = 30.4 V	1175	1300	1425	mA

Table 7. RF characteristics

Test signal: 2-carrier W-CDMA; PAR 8.4 dB at 0.01 % probability on CCDF; 3GPP test model 1; 64 DPCH; f_1 = 1937.5 MHz; f_2 = 1962.5 MHz; f_3 = 1982.5 MHz; f_4 = 1987.5 MHz; RF performance at V_{DS} = 32 V; I_{Dq} = 1300 mA; T_{case} = 25 °C; unless otherwise specified; in a class-AB production test circuit.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
G_p	power gain	$P_{L(AV)}$ = 60 W	17.3	18.0	20.2	dB
RL_{in}	input return loss	$P_{L(AV)}$ = 60 W	-	−13	−7	dB
η_D	drain efficiency	$P_{L(AV)}$ = 60 W	28	32	-	%
$ACPR_{5M}$	adjacent channel power ratio (5 MHz)	$P_{L(AV)}$ = 60 W	-	−31	−28	dBc

7. Test information

7.1 Ruggedness in class-AB operation

The BLF8G19LS-170BV is capable to withstand a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions: V_{DS} = 32 V; I_{Dq} = 1300 mA; P_L = 214 W (CW); f = 1930 MHz and also under the following conditions: V_{DS} = 28 V; I_{Dq} = 1300 mA; P_L = 170 W (CW); f = 1805 MHz.

7.2 Impedance information

Table 8. Typical impedance

I_{Dq} = 1300 mA; main transistor V_{DS} = 32 V.

f	Z_S[1]	Z_L[1]
(MHz)	(Ω)	(Ω)
1930	1.8 – j3.4	1.1 – j2.8
1960	1.8 – j3.4	1.1 – j2.8
1990	1.9 – j4.0	1.0 – j2.8

[1] Z_S and Z_L defined in Figure 1.

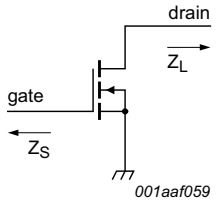
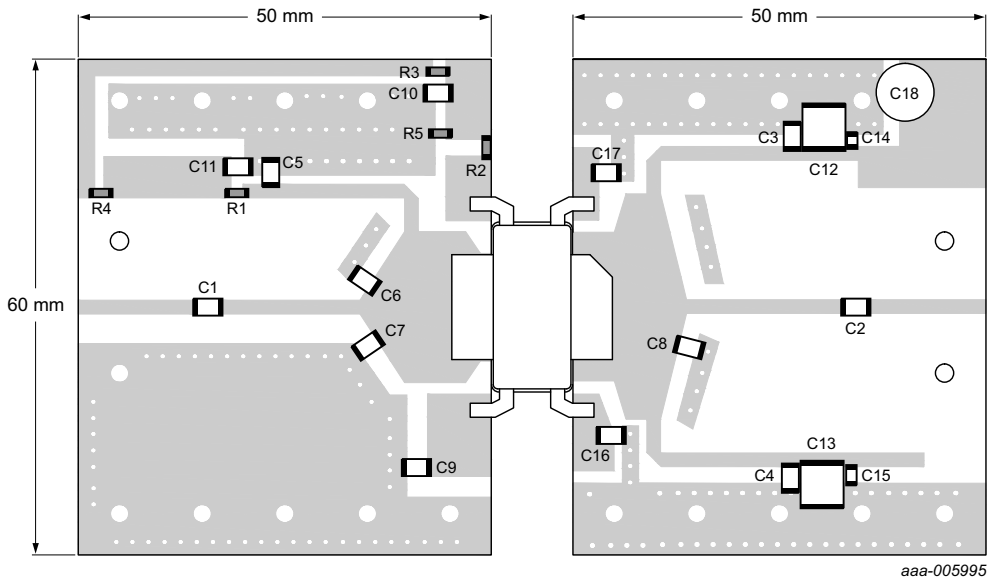


Fig 1. Definition of transistor impedance

7.3 VBW in class-AB operation

The BLF8G19LS-170BV shows 100 MHz (typical) video bandwidth in a class-AB test circuit in the 1900 MHz band at V_{DS} = 32 V and I_{Dq} = 1.3 A.

7.4 Test circuit



Printed-Circuit Board (PCB): Taconic RF35; ε_r = 3.5; thickness = 0.765 mm; thickness copper plating = 35 μm.

See Table 9 for a list of components.

Fig 2. Component layout for class-AB production test circuit

Table 9. List of components

For test circuit see Figure 2.

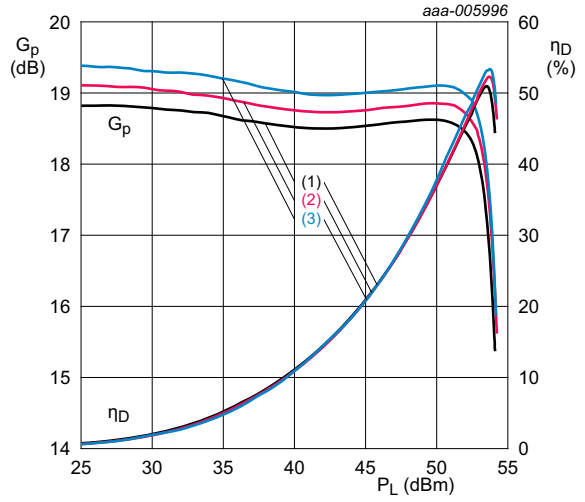
Component	Description	Value	Remarks
C1, C2, C3, C4, C5	multilayer ceramic chip capacitor	10 pF [1]	ATC100B
C6, C8	multilayer ceramic chip capacitor	0.1 pF [1]	ATC100B
C7	multilayer ceramic chip capacitor	0.2 pF [1]	ATC100B
C9, C10	multilayer ceramic chip capacitor	120 pF [1]	ATC100B
C11, C16, C17	multilayer ceramic chip capacitor	4.7 μF, 50 V [2]	Murata
C12, C13	multilayer ceramic chip capacitor	10 μF, 50 V [2]	Murata
C14, C15	multilayer ceramic chip capacitor	1 μF, 50 V [2]	Murata
C18	electrolytic capacitor	470 μF, 63 V	
R1	SMD resistor	4.7 Ω	Philips 1206
R2	SMD resistor	470 Ω	Philips 1206
R3	SMD resistor	820 Ω	Philips 1206
R4	SMD resistor	12 Ω	Philips 1206
R5	SMD resistor	2200 Ω	Philips 1206

[1] American Technical Ceramics type 100B or capacitor of same quality.

[2] Murata or capacitor of same quality.

7.5 Graphs

7.5.1 CW pulse



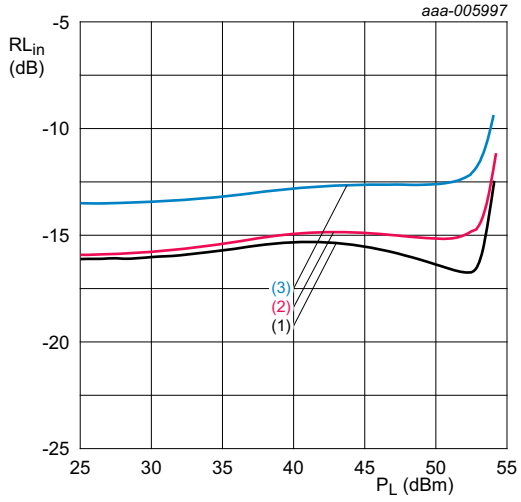
V_{DS} = 32 V; I_{Dq} = 1300 mA; t_p = 100 μs; δ = 10 %.

(1) f = 1935 MHz

(2) f = 1960 MHz

(3) f = 1985 MHz

Fig 3. Power gain and drain efficiency as function of output power; typical values



V_{DS} = 32 V; I_{Dq} = 1300 mA; t_p = 100 μs; δ = 10 %.

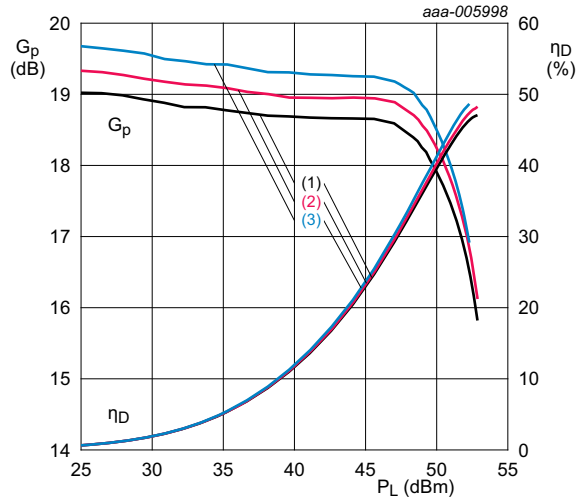
(1) f = 1935 MHz

(2) f = 1960 MHz

(3) f = 1985 MHz

Fig 4. Input return loss as a function of output power; typical values

7.5.2 2-Carrier W-CDMA



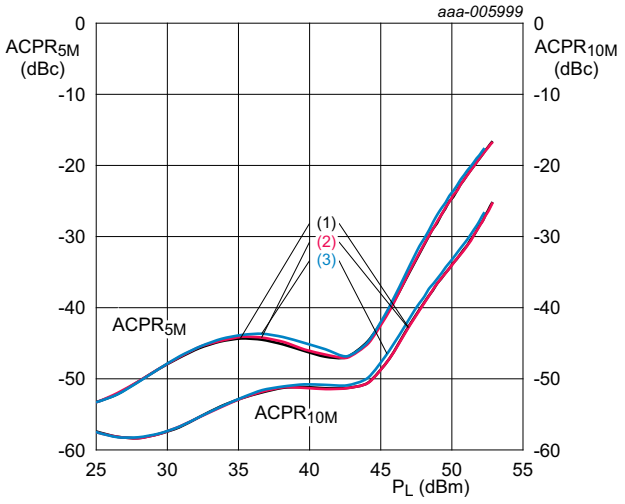
V_{DS} = 32 V; I_{Dq} = 1300 mA.

(1) f = 1935 MHz

(2) f = 1960 MHz

(3) f = 1985 MHz

Fig 5. Power gain and drain efficiency as function of output power; typical values



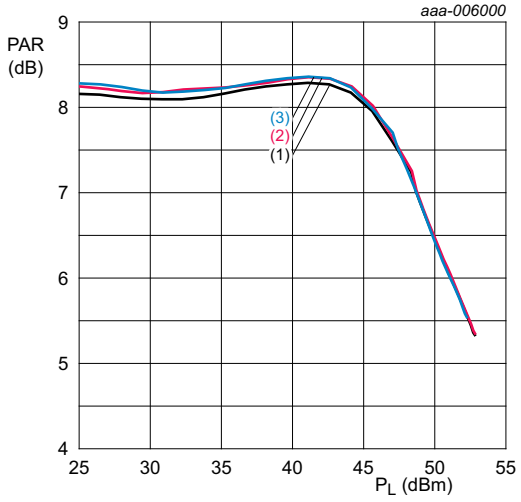
V_{DS} = 32 V; V_{GS} = 32 V

(1) f = 1935 MHz

(2) f = 1960 MHz

(3) f = 1985 MHz

Fig 6. Adjacent channel power ratio (5 MHz) and adjacent channel power ratio (10 MHz) as function of output power; typical values



V_{DS} = 32 V; I_{Dq} = 1300 mA.

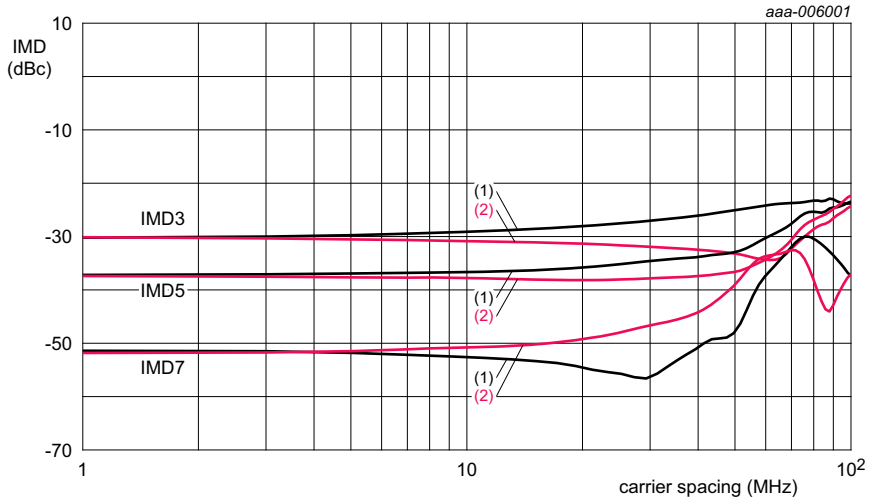
(1) f = 1935 MHz

(2) f = 1960 MHz

(3) f = 1985 MHz

Fig 7. Peak-to-average power ratio as a function of output power; typical values

7.5.3 2-Tone VBW



V_{DS} = 32 V; I_{Dq} = 1300 mA; f_c = 1960 MHz.

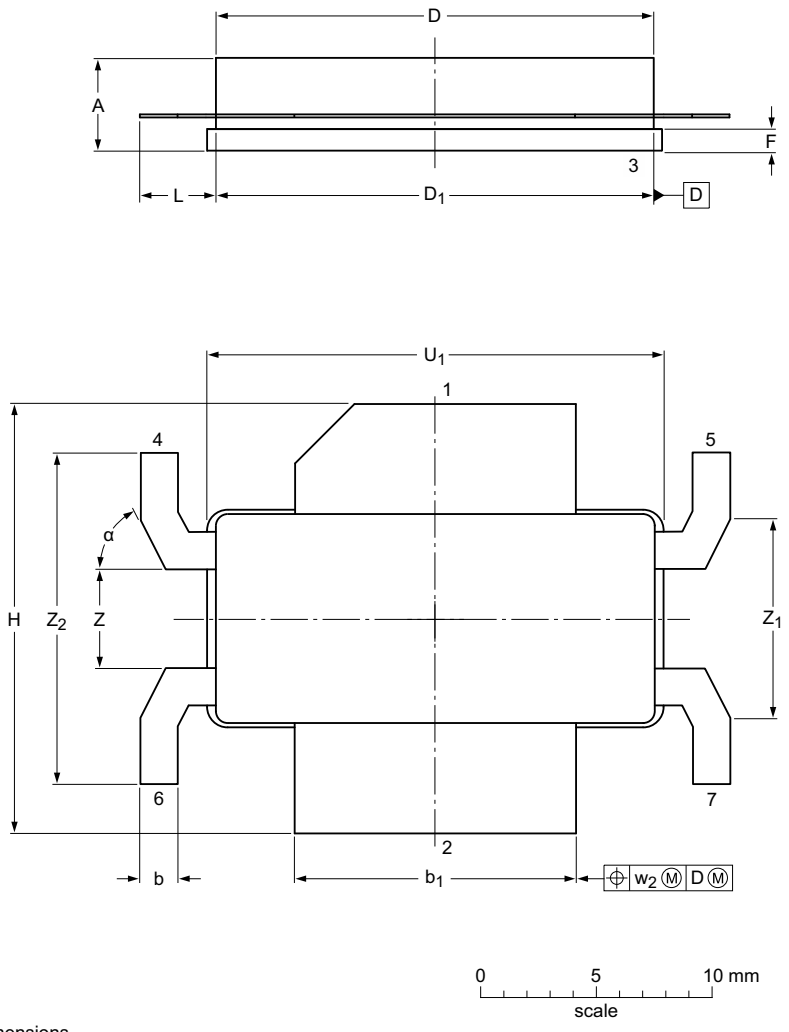
(1) low frequency component

(2) high frequency component

Fig 8. VBW capability in class-AB test circuit

8. Package outline

Earless flanged LDMOST ceramic package; 6 leads **SOT1120B**



Dimensions

Unit[1]		A	b	b_1	c	D	D_1	E	E_1	F	H	L	Q[2]	U_1	U_2	w_2	y	Z	Z_1	Z_2	α
mm	max	4.75	1.83	12.83	0.18	20.02	19.96	9.53	9.53	1.14	19.94	3.56	1.70	20.70	9.91		0.10	4.60	9.53	15.52	64°
	nom															0.51					
	min	3.45	1.57	12.57	0.10	19.61	19.66	9.27	9.25	0.89	18.92	3.30	1.45	20.45	9.65			4.32	8.71	14.50	60°
inches	max	0.187	0.072	0.505	0.007	0.788	0.786	0.375	0.375	0.045	0.785	0.140	0.067	0.815	0.39		0.004	0.181	0.375	0.611	64°
	nom															0.02					
	min	0.136	0.062	0.495	0.004	0.772	0.774	0.365	0.364	0.035	0.745	0.130	0.057	0.805	0.38			0.170	0.343	0.571	60°

Note
1. millimeter dimensions are derived from the original inch dimensions.
2. dimension is measured 0.030 inch (0.76 mm) from the body.

sot1120b_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT1120B						~~12-06-14~~ 13-10-21

Fig 9. Package outline SOT1120B

9. Abbreviations

Table 10. Abbreviations

Acronym	Description
3GPP	3rd Generation Partnership Project
CCDF	Complementary Cumulative Distribution Function
CW	Continuous Wave
DPCH	Dedicated Physical CHannel
ESD	ElectroStatic Discharge
LDMOS	Laterally Diffused Metal Oxide Semiconductor
LDMOST	Laterally Diffused Metal Oxide Semiconductor Transistor
MTF	Median Time to Failure
PAR	Peak-to-Average Ratio
VBW	Video BandWidth
VSWR	Voltage Standing Wave Ratio
W-CDMA	Wideband Code Division Multiple Access

10. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BLF8G19LS-170BV#4	20150901	Product data sheet		BLF8G19LS-170BV v.3
Modifications:	• The format of this document has been redesigned to comply with the new identity guidelines of Ampleon. • Legal texts have been adapted to the new company name where appropriate.			
BLF8G19LS-170BV v.3	20150501	Product data sheet	-	BLF8G19LS-170BV v.2
BLF8G19LS-170BV v.2	20130328	Product data sheet	-	BLF8G19LS-170BV v.1
BLF8G19LS-170BV v.1	20130108	Preliminary data sheet	-	-

11. Legal information

11.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.ampleon.com.

11.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. Ampleon does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local Ampleon sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between Ampleon and its customer, unless Ampleon and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the Ampleon product is deemed to offer functions and qualities beyond those described in the Product data sheet.

11.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, Ampleon does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. Ampleon takes no responsibility for the content in this document if provided by an information source outside of Ampleon.

In no event shall Ampleon be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, Ampleon' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of Ampleon.

Right to make changes — Ampleon reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — Ampleon products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an Ampleon product can reasonably be expected to result in personal injury, death or severe property or environmental damage. Ampleon and its suppliers accept no liability for inclusion and/or use of Ampleon products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. Ampleon makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using Ampleon products, and Ampleon accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the Ampleon product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

Ampleon does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using Ampleon products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). Ampleon does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — Ampleon products are sold subject to the general terms and conditions of commercial sale, as published at http://www.ampleon.com/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. Ampleon hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of Ampleon products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Non-automotive qualified products — Unless this data sheet expressly states that this specific Ampleon product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. Ampleon accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without Ampleon' warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond Ampleon' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies Ampleon for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond Ampleon' standard warranty and Ampleon' product specifications.

Translations — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

11.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

Any reference or use of any 'NXP' trademark in this document or in or on the surface of Ampleon products does not result in any claim, liability or entitlement vis-à-vis the owner of this trademark. Ampleon is no longer part of the NXP group of companies and any reference to or use of the 'NXP' trademarks will be replaced by reference to or use of Ampleon's own Any reference or use of any 'NXP' trademark in this document or in or on the surface of Ampleon products does not result in any claim, liability or entitlement vis-à-vis the owner of this trademark. Ampleon is no longer part of the NXP group of companies and any reference to or use of the 'NXP' trademarks will be replaced by reference to or use of Ampleon's own trademarks.

12. Contact information

For more information, please visit:
http://www.ampleon.com

For sales office addresses, please visit:
http://www.ampleon.com/sales

13. Contents

For more information, please visit: http://www.ampleon.com
For sales office addresses, please visit: http://www.ampleon.com/sales

Date of release: 1 September 2015
Document identifier: BLF8G19LS-170BV#4